

### Low-Power Long Range (LoRa®) Technology Gateway Module for US (LG9271) and EU (LG8271)

#### **General Features**

- Supports LoRa<sup>®</sup>/LoraWAN™ Technology RF Packets
- Up to eight receive and one transmit channel(s)
- · UART (TTL) interface with built-in control protocol
- Compact form factor 90.0 mm x 30.0 mm
- · mPCle physical connector
- · Environmentally friendly RoHS compliant
- · Compliance:
  - LG8271: Certified to R&TTE RF Standards
  - LG9271: Certified to FCC Modular Transmitter Standards
- Device Firmware Upgrade (DFU) over UART, see "LoRa® Technology Gateway Module Software Specifications"

### **Operational**

- Single operating voltage: 3.0V to 3.6V (3.3V nominal)
- Temperature range: -40 to +85 °C
- Supports LoRa Technology (12.5 kbps) and FSK (EU only) (up to 300 kbps) modulations
- Integrated frequency matched RF front end, RF transceiver, baseband processor, and MCU

### **Description**

Microchip's LG8271/LG9271 Low-Power Long Range (LoRa) Technology transceiver modules provide an easy to use, low-power solution for long range wireless data reception. Each module provides eight LoRa Technology receive channels (125 kHz Bandwith (BW)). In addition to the eight LoRa Technology receive channels, the modules provide two additional receive channels. The first is a LoRa Technology modulation receive channel capable of 125, 250 or 500 kHz BW). The second provides an FSK/GFSK (EU only) receive channel.

Beyond its receiver capability, the modules provide a single flexibly transmit channel. This transmit channel is capable of both LoRa Technology and FSK/GFSK modulations at multiple bandwidths (LoRa Technology) or baud rates (FSK/GFSK).

The multi-channel, flexible nature of these modules makes them ideal for use in LoRa Technology gateway applications.

The advanced command protocol available over the UART interface provides complete control over the full capabilities of RF subsystem in addition to packet reception and transmission.

### **Applications**

Applications deploying LoRa Technology where gateway devices are required include:

- · Automated Meter Reading
- · Home and Building Automation
- · Wireless Alarm and Security Systems
- · Industrial Monitoring and Control
- Machine to Machine (M2M)
- Internet of Things (IoT)

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### 1.0 DEVICE OVERVIEW

The LG8271/LG9271 transceiver modules feature LoRa Technology RF modulation, which provides long range spread spectrum communication with high interference immunity.

Each module supports eight (8) receive channels allowing it to receive up to eight LoRa Technology modulated packets simultaneously. By using LoRa Technology modulation technique, LG8271/LG9271 can achieve a receiver sensitivity of -146 dBm. When combined with LoRa Technology transmission devices, the LG8271/LG9271 can provide a system with industry leading link budget, which makes it optimal for applications requiring extended range and robustness.

The LG8271/LG9271 modules also contain an integrated output power amplifier (LNA) providing optimal downlink signal levels.

LoRa Technology modulation also provides significant advantages in both blocking and selectivity compared to the conventional modulation techniques, solving the traditional design compromise between extended range, interference immunity, and low-power consumption.

The LG8271/LG9271 modules deliver exceptional RF selectivity and their multi-channel performance make them ideal for use in LoRa Technology gateway applications.

Figure 1-1, Figure 1-2 and Figure 1-3 show the top and bottom view, the pinout, and the block diagram of the modules.

FIGURE 1-1: TOP VIEW

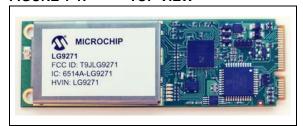


FIGURE 1-2: PIN DIAGRAM

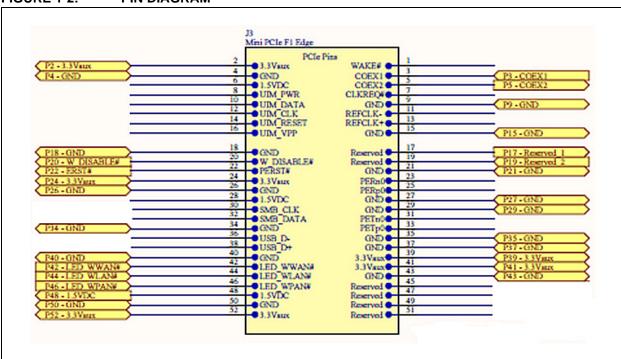


FIGURE 1-3: BLOCK DIAGRAM

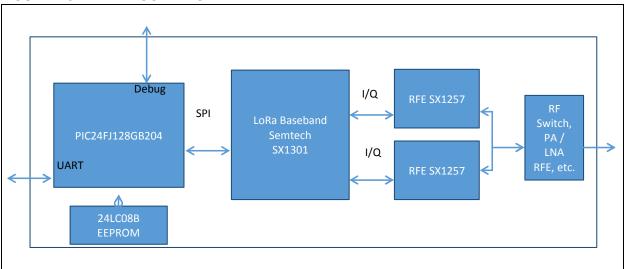


Table 1-1 describes the pins of the module.

TABLE 1-1: PIN DESCRIPTION

Pin	Symbol	Туре	Description
1	NC	<del>_</del>	Not Connected
2	VDD	Power	Positive Supply Terminal
3	HOST_INT	Output	Interrupt to the Host CPU
4	GND	Power	Ground Supply Terminal
5	PPS	Input	GPS PPS Input signal
6	NC	_	Not Connected
7	NC	_	Not Connected
8	NC	<del>_</del>	Not Connected
9	GND	Power	Ground Supply Terminal
10	NC	_	Not Connected
11	NC	<del>_</del>	Not Connected
12	NC	_	Not Connected
13	NC	_	Not Connected
14	NC	_	Not Connected
15	GND	Power	Ground Supply Terminal
16	NC	_	Not Connected
17	HOST_URX	Input	Module UART Receive
18	GND	Power	Ground Supply Terminal
19	HOST_UTX	Output	Module UART Transmit
20	RF_ENABLE	Input	RF Enable Input
21	GND	Power	Ground Supply Terminal
22	RESET	Input	Reset Module
23	NC	_	Not Connected
24	VDD	Power	Positive Supply Terminal
25	NC	<del>_</del>	Not Connected
26	GND	Power	Ground Supply Terminal
27	GND	Power	Ground Supply Terminal
28	NC	<del>_</del>	Not Connected

TABLE 1-1: PIN DESCRIPTION (CONTINUED)

Pin	Symbol	Туре	Description
29	GND	Power	Ground Supply Terminal
30	HOST_CLK	Input	Host I <sup>2</sup> C Clock
31	NC	_	Not Connected
32	HOS_SDA	Input/Output	HOST I <sup>2</sup> C Data
33	NC	_	Not Connected
34	GND	Power	Ground Supply Terminal
35	GND	Power	Ground Supply Terminal
36	USB_D-	_	Host USB D-
37	GND	Power	Ground Supply Terminal
38	USB_D+	_	Host USB D+
39	VDD	Power	Positive Supply Terminal
40	GND	Power	Ground Supply Terminal
41	VDD	Power	Positive Supply Terminal
42	LED1	Output	LED1 Output
43	GND	Power	Ground Supply Terminal
44	LED2	Output	LED2 Output
45	HOST_MISO	Ouput	Module SPI Slave Output
46	LED3	Output	LED3 Output
47	HOST_MISO	Input	Module SPI Slave Input
48	PIC_DETECT	Input/Output	PCI Bus Detect Input. Low = SPI Mode, High = mPCIe/UART
49	HOST_SS	Input	Module SPI Slave Select Input
50	GND	Power	Ground Supply Terminal
51	HOST_SCK	Input	Module SPI Clock Input
52	VDD	Power	Positive Supply Terminal

NOTES:

### 2.0 GENERAL SPECIFICATIONS

Table 2-1 provide the general specifications for the module. Table 2-2 through Table 2-4 provide the electrical characteristics, RF receiver characteristics, LoRa Technology data rate and sensitivity versus spreading factor.

TABLE 2-1: GENERAL SPECIFICATION

Specification	Description
Frequency Band - LG9271	902.000 MHz to 928.000 MHz
Frequency Band - LG8271	863.000 MHz to 870.000 MHz
Modulation Method	FSK (EU only), GFSK (EU only), and LoRa <sup>®</sup> Technology modulation
Maximum Over-the-Air Data Rate	200 kbps (FSK);
	21875 bps (LoRa Technology, see Table 2-4) <sup>(1)</sup>
RF Connection	On-board U.FL connector
Interface	UART (TTL)
Operation Range	Up to 15 km coverage at suburban; up to 5 km coverage at urban area
RF TX Power - LG9271	Adjustable, < +18.5 dBm <sup>(2)</sup>
RF TX Power - LG8271	Adjustable, < +14.0 dBm <sup>(2)</sup>
Generated Conductive Harmonics Level	Below -70 dBm
Temperature (operating)	-40°C to +85°C
Temperature (storage)	-40°C to +115°C
Humidity	10% ~ 90% Non-condensing

Note 1: Depends on modulation and Expand Spreading Factor (SF)

TABLE 2-2: ELECTRICAL CHARACTERISTICS

Parameter	Min.	Тур.	Max.	Units
Supply Voltage	3.0	_	3.6	V
Voltage on any pin with respect to VSS (except VDD)	-0.3	_	-VDD + 0.3	V
Voltage on VDD with respect to VSS	-0.3	_	3.9	V
Input Clamp Current (IIK) (VI < 0 or VI > VDD)	_	_	+/-20	mA
Output Camp Current (IOK) (VO < 0 or VO > VDD)	_	_	+/-20	mA
GPIO sink/source current each	_	_	25/25	mA
Total GPIO sink/source current	_	_	200/185	mA
RAM Data Retention Voltage (in Sleep mode or Reset state)	1.5	_	_	V
VDD Start Voltage to ensure internal Power-on Reset signal	_	_	0.7	V
VDD Rise Rate to ensure internal Power-on Reset signal	0.05	_	_	V/ms
Brown-out Reset Voltage	1.75	1.9	2.05	V
Logic Input Low Voltage	_	_	0.15 x VDD	V
Logic Input High Voltage	0.8 x VDD	_	-	V
Input Leakage at <25°C (VSS <vpin<vdd, at="" high-impedance)<="" pin="" td=""><td>_</td><td>0.1</td><td>50</td><td>nA</td></vpin<vdd,>	_	0.1	50	nA

**<sup>2:</sup>** TX power is adjustable. For more information, refer to the "LoRa® Technology Gateway Module Software Specifications"

TABLE 2-2: ELECTRICAL CHARACTERISTICS (CONTINUED)

Parameter	Min.	Тур.	Max.	Units
Input Leakage at +60°C (VSS <vpin<vdd, at="" high-impedance)<="" pin="" td=""><td>_</td><td>0.7</td><td>100</td><td>nA</td></vpin<vdd,>	_	0.7	100	nA
RF Input Level	_	0	+6	dBm

TABLE 2-3: RF RECEIVER CHARACTERISTICS

Descriptions	Conditions	Тур	Unit
LoRa Technology sensitivity at SF12 : IF8 path	BW = 125 kHz BW = 250 kHz BW = 500 kHz	-140 -137 -134	dBm
LoRa Technology sensitivity at SF12: IF0 to 7 paths	BW = 125 kHz	-140	dBm
Receiver CW interferer rejection at 1Mhz offset at SF12	BW = 125 kHz	+80	dB
Co-channel rejection at SF12	Wanted signal 10 dB above sensitivity	+25	dB
LoRa Technology sensitivity at SF7: IF8 path	BW = 125 kHz BW = 250 kHz BW = 500 kHz	-126 -123 -120	dBm
LoRa Technology sensitivity at SF7: IF0 to 7 paths	BW = 125 kHz	-126	dBm
Receiver CW interferer rejection at 1 Mhz offset	BW = 125 kHz	+70	dB
Co-channel rejection at SF7	Wanted signal 10 dB above sensitivity	+9	dB
FSK sensitivity	FDev = 50 kHz, Bit Rate = 100 kb/s	-103	dBm
Bit rate FSK <sup>(1)</sup>	Programmable	1.2 to 100	kbps
Frequency deviation (FDev), FSK	Programmable	0.6 to 200	kHz

Note 1: Bit rate limited by: FDev + Bit Rate/2 < 250 kHz

TABLE 2-4: Lora TECHNOLOGY DATA RATE (BPS) AND SENSITIVITY VERSUS SPREADING FACTOR (SF)

er.	125 kHz		250 kHz <sup>(1)</sup>		500 kHz <sup>(1)</sup>	
SF	Data Rate	Sensitivity	Data Rate	Sensitivity	Data Rate	Sensitivity
7	5496	-130.0	10938	-127.0	21875	-124.0
8	2125	-132.5	6250	-129.5	12500	-126.5
9	1758	-135.0	3516	-132.0	7031	-129.0
10	977	-137.5	1953	-134.5	3906	-131.5
11	537	-140.0	1074	-137.0	2148	-134.0
12	293	-142.5	586	-139.5	1172	-136.5

Note 1: 250 kHz and 500 kHz LoRa Technology bandwidths are available only on IF8.

Table 2-5 through Table 2-7 provide the current consumption, dimensions of the modules and the RF output power versus TX power settings.

TABLE 2-5: CURRENT CONSUMPTION (3.3V)

Mode	Current (Typical) mA	Current (Max.) mA
RF Idle	75	100
RX Active	570	850
TX Active	570	900

### TABLE 2-6: MODULE DIMENSIONS

Parameter	Value
Dimensions	90.0 x 30.0 mm
Weight	16g

TABLE 2-7: RF OUTPUT POWER (DBM) VERSUS TX POWER SETTING (NOMINAL)

Setting	Power	Setting	Power	Setting	Power	Setting	Power	Setting	Power
-6	-6	1	0	8	6	15 <sup>(1)</sup>	14	22(1)	20
-5	-6	2	0	9	6	16 <sup>(1)</sup>	16	23 <sup>(1)</sup>	23
-4	-6	3	3	10	10	17 <sup>(1)</sup>	16	24 <sup>(1)</sup>	23
-3	-3	4	3	11	11	18 <sup>(1)</sup>	16	25 <sup>(1)</sup>	25
-2	-3	5	3	12	12	19 <sup>(1)</sup>	16	26 <sup>(1)</sup>	26
-1	-3	6	6	13	13	20 <sup>(1)</sup>	20	27 <sup>(1)</sup>	27
0	0	7	6	14(1)	14	21 <sup>(1)</sup>	20		

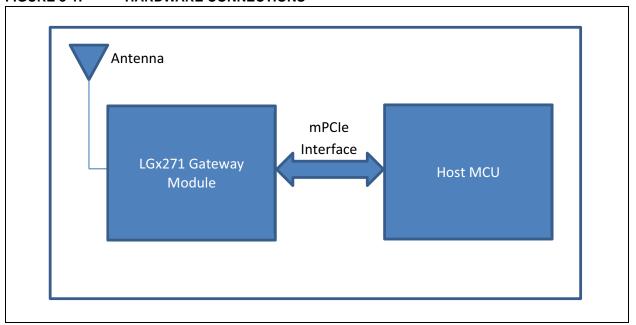
**Note 1:** Power settings 14 - 27 may violate ETSI maximum RF transmit power levels. Verify RF output power before using these settings.

NOTES:

# 3.0 TYPICAL HARDWARE CONNECTIONS

Figure 3-1 shows the typical hardware connections for the module. Interfacing to the module requires connecting to the signals provided on the mPCIe connector as listed in Table 1-1. Specific interface connection are discussed in this chapter.

FIGURE 3-1: HARDWARE CONNECTIONS



### 3.1 INTERFACE TO HOST MCU

The LG8271/LG9271 modules have a dedicated UART interface to communicate with a host controller. The "LoRa® Technology Gateway Module Software Specifications" provides a detailed UART command description. Table 3-1 shows the default settings for the UART interface.

TABLE 3-1: UART SETTINGS

Specification	Value
Signal Levels	TTL
Baud Rate	115200 bps
Packet Length	8 bit
Parity Bit	No
Stop Bits	1 bit
Hardware Flow Control	No

### 3.2 RF CONNECTION

The LG8271/LG9271 modules have a U.FL connector for interfacing with an external antenna. For proper operation, antenna selection must consider frequency band and impedance.

### 3.3 POWER PINS

The LG8271/LG9271 modules have multiple power and ground pins available on the mPCle connector. It is recommended that all power and ground pins be used when connecting to the module.

### 3.4 RESET PIN

The LG8271/LG9271 modules have an active-low reset input. Pulling this signal low during normal operation will cause the module to execute a reset cycle.

### 3.5 RF\_ENABLE

The LG8271/LG9271 modules have an input signal used to enable the RF radio on the module. A low level on the RF\_ENABLE pin will disable all RF transmission and reception.

### 3.6 PCI\_DETECT

The LG8271/LG9271 modules have an input signal used to select the active host interface. The signal is sampled at module start up and the selected interface is initialized and configured. A LOW signal on this line at start up selects the SPI interface (unsupported). A HIGH signal on this line selects the UART interface.

### 3.7 LED OUTPUTS

The LG8271/LG9271 modules have three buffered outputs that can sink sufficient current to activate off board LEDs. These signals are entirely controlled by commands from the host MCU. Refer to the "LoRa® Technology Gateway Module Software Specifications" for details regarding the commands used to activate these signals.

### 3.8 HOST INTERRUPT

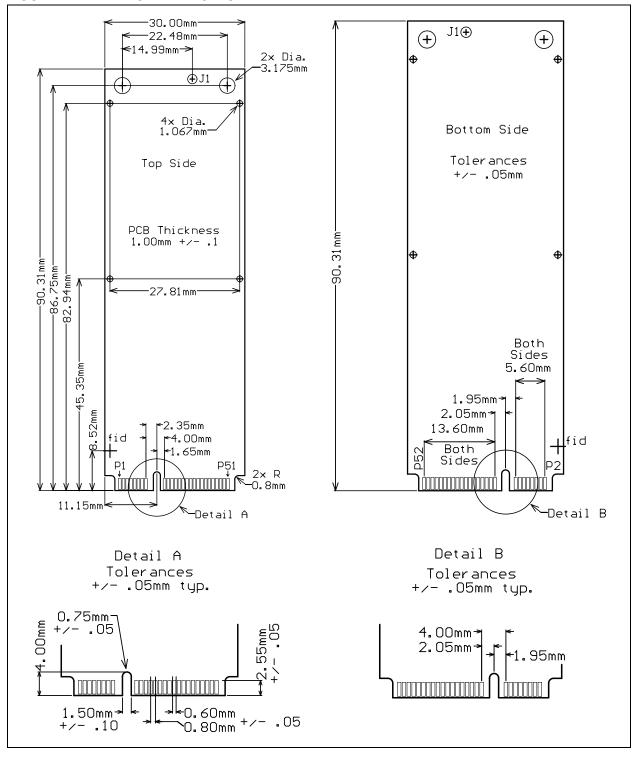
The LG8271/LG9271 modules have an output signal that can be used to provide an interrupt to a host MCU. This feature is currently implemented.

### 4.0 APPLICATION INFORMATION

### 4.1 Physical Dimensions

Figure 4-1 and Figure 4-2 illustrate the physical dimensions of the LG8271/LG9271 modules.

FIGURE 4-1: TOP AND BOTTOM VIEW



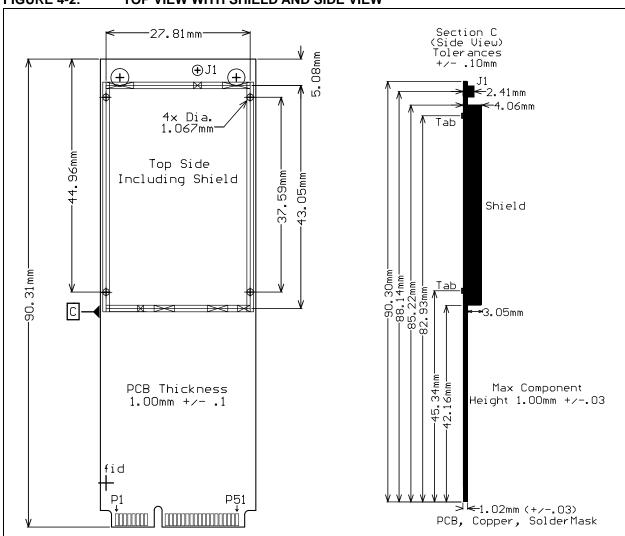


FIGURE 4-2: TOP VIEW WITH SHIELD AND SIDE VIEW

### 4.2 Approved Antennas

Modular certification of the LG9271 module is performed with the external antenna type in Table 4-1.

For specific regulatory requirements by country, refer to **Section 5.0 "Regulatory Approval"**.

TABLE 4-1: TESTED EXTERNAL ANTENNA TYPES

Туре	Gain (dBi)
Sleeve Dipole	5

### 5.0 REGULATORY APPROVAL

This section outlines the regulatory information for the LG8271/LG9271 module for the following countries:

- Europe (LG8271)
- · United States (LG9271)

### 5.1 Europe

The LG8271 module has been tested in accordance with the ETSI EN 300 220-2 V2.4.1 (2012-05) RF standard and been determined to be compliant. Table 5-1 lists the summary report documenting the compliance.

Additional R&TTE testing is required for Health and Safety (Article (3.1(a)) and Electromagnetic Compatibility (EMC) (Article 3.1(b)).

The R&TTE Compliance Association provides guidance on modular devices in document **Technical Guidance Note 01** available at

http://www.rtteca.com/html/download area.htm.

### Note:

To maintain conformance to the testing listed in Table 5-1: European Compliance Testing, the module shall be installed in accordance with the installation instructions in this data sheet and shall not be modified.

When integrating a radio module into a completed product the integrator becomes the manufacturer of the final product and is therefore responsible for demonstrating compliance of the final product with the essential requirements of the R&TTE Directive.

### 5.1.1 LABELING AND USER INFORMATION REQUIREMENTS

The label on the final product which contains the LG8271 module must follow CE marking requirements. The "R&TTE Compliance Association Technical Guidance Note 01" provides guidance on final product CE marking.

### 5.1.2 EXTERNAL ANTENNA REQUIREMENTS

From R&TTE Compliance Association document **Technical Guidance Note 01**:

Provided the integrator installing an assessed radio module with an integral or specific antenna and installed in conformance with the radio module manufacturer's installation instructions requires no further evaluation under Article 3.2 of the R&TTE Directive and does not require further involvement of an R&TTE Directive Notified Body for the final product. [Section 2.2.4]

### 5.1.3 HELPFUL WEB SITES

A document that can be used as a starting point in understanding the use of Short Range Devices (SRD) in Europe is the European Radio Communications Committee (ERC) Recommendation 70-03 E, which can be downloaded from the European Radio Communications Office (ERO) at: http://www.ero.dk/.

Additional helpful web sites are:

- Radio and Telecommunications Terminal Equipment (R&TTE): http://ec.europa.eu/enterprise/sectors/rtte/ regulatory-framework/index en.htm
- European Conference of Postal and Telecommunications Administrations (CEPT): http://www.cept.org
- European Telecommunications Standards Institute (ETSI): http://www.etsi.org
- European Radio Communications Office (ERO): http://www.ero.dk/
- The Radio and Telecommunications Terminal Equipment Compliance Association (R&TTE CA): http://www.rtteca.com/

TABLE 5-1: EUROPEAN COMPLIANCE TESTING

Certification	Standards	Article	Laboratory	Report Number	Date
Safety	IEC 60950-1:2005 (2nd Ed: A1:2009)	(3.1(a))			
Health	EN 62479	_			
EMC	EN 301 489-3 v1.6.1	(3.1(b))			
Radio	EN 300 220-2 v2.4.1	(3.2)	TÜV SÜD AMERICA INC.	TP72121077.100	11/14/2015

#### 5.2 United States

The LG9271 module has received Federal Communications Commission (FCC) CFR47 Telecommunications, Part 15 Subpart C "Intentional Radiators" modular approval in accordance with Part 15.212 Modular Transmitter approval. Modular approval allows the end user to integrate the LG9271 module into a finished product without obtaining subsequent and separate FCC approvals for intentional radiation, provided no changes or modifications are made to the module circuitry. Changes or modifications could void the user's authority to operate the equipment. The end user must comply with all of the instructions provided by the Grantee, which indicate installation and/or operating conditions necessary for compliance.

The finished product is required to comply with all applicable FCC equipment authorizations regulations, requirements and equipment functions not associated with the transmitter module portion. For example, compliance must be demonstrated to regulations for other transmitter components within the host product; to requirements for unintentional radiators (Part 15 Subpart B "Unintentional Radiators"), such as digital devices, computer peripherals, radio receivers, etc.; and to additional authorization requirements for the non-transmitter functions on the transmitter module (i.e., Verification, or Declaration of Conformity) (e.g., transmitter modules may also contain digital logic functions) as appropriate.

### 5.2.1 LABELING AND USER INFORMATION REQUIREMENTS

The LG9271 module has been labeled with its own FCC ID number, and if the FCC ID is not visible when the module is installed inside another device, then the outside of the finished product into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording as follows:

Contains Transmitter Module FCC ID: T9JLG9271 or

Contains FCC ID: T9JLG9271

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

A user's manual for the finished product should include the following statement:

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy, and if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- · Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

Additional information on labeling and user information requirements for Part 15 devices can be found in KDB Publication 784748 available at the FCC Office of Engineering and Technology (OET) Laboratory Division Knowledge Database (KDB) https://apps.fcc.gov/oetcf/kdb/index.cfm.

#### 5.2.2 RF EXPOSURE

All transmitters regulated by FCC must comply with RF exposure requirements. KDB 447498 General RF Exposure Guidance provides guidance in determining whether proposed or existing transmitting facilities, operations or devices comply with limits for human exposure to Radio Frequency (RF) fields adopted by the Federal Communications Commission (FCC).

From the LG9271 FCC Grant: Output power listed is conducted. This grant is valid only when the module is sold to OEM integrators and must be installed by the OEM or OEM integrators. This transmitter is restricted for use with the specific antenna(s) tested in this application for Certification and must not be co-located or operating in conjunction with any other antenna or transmitters within a host device, except in accordance with FCC multi-transmitter product procedures.

### 5.2.3 APPROVED EXTERNAL ANTENNA TYPES

To maintain modular approval in the United States, only the antenna types that have been tested shall be used. It is permissible to use different antenna manufacturer provided the same antenna type and antenna gain (equal to or less than) is used.

Testing of the LG9271 module was performed with the antenna types listed in Table 4-1 Tested External Antenna Types.

### 5.2.4 HELPFUL WEB SITES

Federal Communications Commission (FCC): http://www.fcc.gov

FCC Office of Engineering and Technology (OET) Laboratory Division Knowledge Database (KDB): https://apps.fcc.gov/oetcf/kdb/index.cfm

### 5.3 Canada

The LG8271 module has been certified for use in Canada under Industry Canada (IC) Radio Standards Specification (RSS) RSS-247 and RSS-Gen. Modular approval permits the installation of a module in a host device without the need to recertify the device.

# 5.3.1 LABELING AND USER INFORMATION REQUIREMENTS

Labeling Requirements for the Host Device (from Section 3.1, RSS-Gen, Issue 4, November 13, 2014): The host device shall be properly labeled to identify the module within the host device.

The Industry Canada certification label of a module shall be clearly visible at all times when installed in the host device, otherwise the host device must be labeled to display the Industry Canada certification number of the module, preceded by the words "Contains transmitter module", or the word "Contains", or similar wording expressing the same meaning, as follows:

Contains transmitter module IC: 6514A-LG9271.

User Manual Notice for License-Exempt Radio Apparatus (from Section 8.4 RSS-Gen, Issue 4, November 13, 2014): User manuals for license-exempt radio apparatus shall contain the following or equivalent notice in a conspicuous location in the user manual or alternatively on the device or both:

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Transmitter Antenna (from Section 8.3 RSS-Gen, Issue 4, November 13, 2014): User manuals for transmitters shall display the following notice in a conspicuous location:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication.

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

The above notice may be affixed to the device instead of displayed in the user manual.

User manuals for transmitters equipped with detachable antennas shall also contain the following notice in a conspicuous location:

This radio transmitter (identify the device by certification number, or model number if Category II) has been approved by Industry Canada to operate with the antenna types listed below with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

Immediately following the above notice, the manufacturer shall provide a list of all antenna types approved for use with the transmitter, indicating the maximum permissible antenna gain (in dBi) and required impedance for each.

#### 5.3.2 RF EXPOSURE

All transmitters regulated by IC must comply with RF exposure requirements listed in RSS-102 - Radio Frequency (RF) Exposure Compliance of Radiocommunication Apparatus (All Frequency Bands). Currently this device is approved for use for when 20 cm can be maintained between the antenna and users.

Specific Absorption Rate (SAR) evaluation is required if the separation distance between the user and/or bystander and the antenna and/or radiating element of the device is less than or equal to 20 cm. Exceptions are listed in RSS-102. Note that integration < 20 cm will require further certification with IC such as a Multiple listing and Class IV Permissive Change application.

Tous les émetteurs régulés par Industrie Canada doivent être conformes à la notice RSS-102 d'Industrie Canada concernant la Conformité des appareils de radiocommunication aux limites d'exposition humaine aux radiofréquences (toutes bandes de fréquences). Ce produit est ainsi approuvé pour une utilisation d'au moins 20 cm entre l'antenne et toute personne à proximité.

Une évaluation du Débit d'Absorption Spécifique (DAS) est requise si cette distance de séparation est inférieure ou égale à 20 cm. Des exceptions sont toute-fois répertoriés dans la notice RSS-102. Mais il est souligné que l'utilisation d'un dispositif à moins de 20 cm nécessite une certification supplémentaire avec Industrie Canada, comme un complément d'information et l'application à la notice de Changement Permissif de Classe IV.

### 5.3.3 APPROVED EXTERNAL ANTENNA TYPES

Transmitter Antenna (from Section 8.3 RSS-Gen, Issue 4, November 13, 2014):

The LG9271 module can only be sold or operated with antennas with which it was approved. Transmitter may be approved with multiple antenna types. An antenna type comprises antennas having similar in-band and out-of-band radiation patterns. Testing shall be performed using the highest gain antenna of each combination of transmitter and antenna type for which approval is being sought, with the transmitter output power set at the maximum level. Any antenna of the same type having equal or lesser gain as an antenna that had been successfully tested with the transmitter, will also be considered approved with the transmitter, and may be used and marketed with the transmitter.

When a measurement at the antenna connector is used to determine RF output power, the effective gain of the device's antenna shall be stated, based on measurement or on data from the antenna manufacturer. For transmitters of output power greater than 10 milliwatts, the total antenna gain shall be added to the measured RF output power to demonstrate compliance to the specified radiated power limits.

Testing of the LG9271 module was performed with the antenna types listed in Table 4-1 Tested External Antenna Types.

### 5.3.4 HELPFUL WEB SITES

Industry Canada: http://www.ic.gc.ca/

### APPENDIX A: REVISION HISTORY

### Revision A (March 2017)

This is the initial released version of the document.

NOTES:

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Technical support is available through the web site at: http://microchip.com/support

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To order or obtain information, for example, on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	<u> </u>	<u>RM</u>	<u>XXX</u>	Example:
Device	Temperature Range	Package	Firmware Revision Number	LG8271-I/RM000: Industrial temperature
Device:	LG8271/LG9271: Low Tec	v-Power Long R hnology Transc	Range LoRa <sup>®</sup> eeiver module	
Temperature Range:	=-40°C to +85°	C (Industrial)		
Package:	RM = Radio Mod	ule		

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